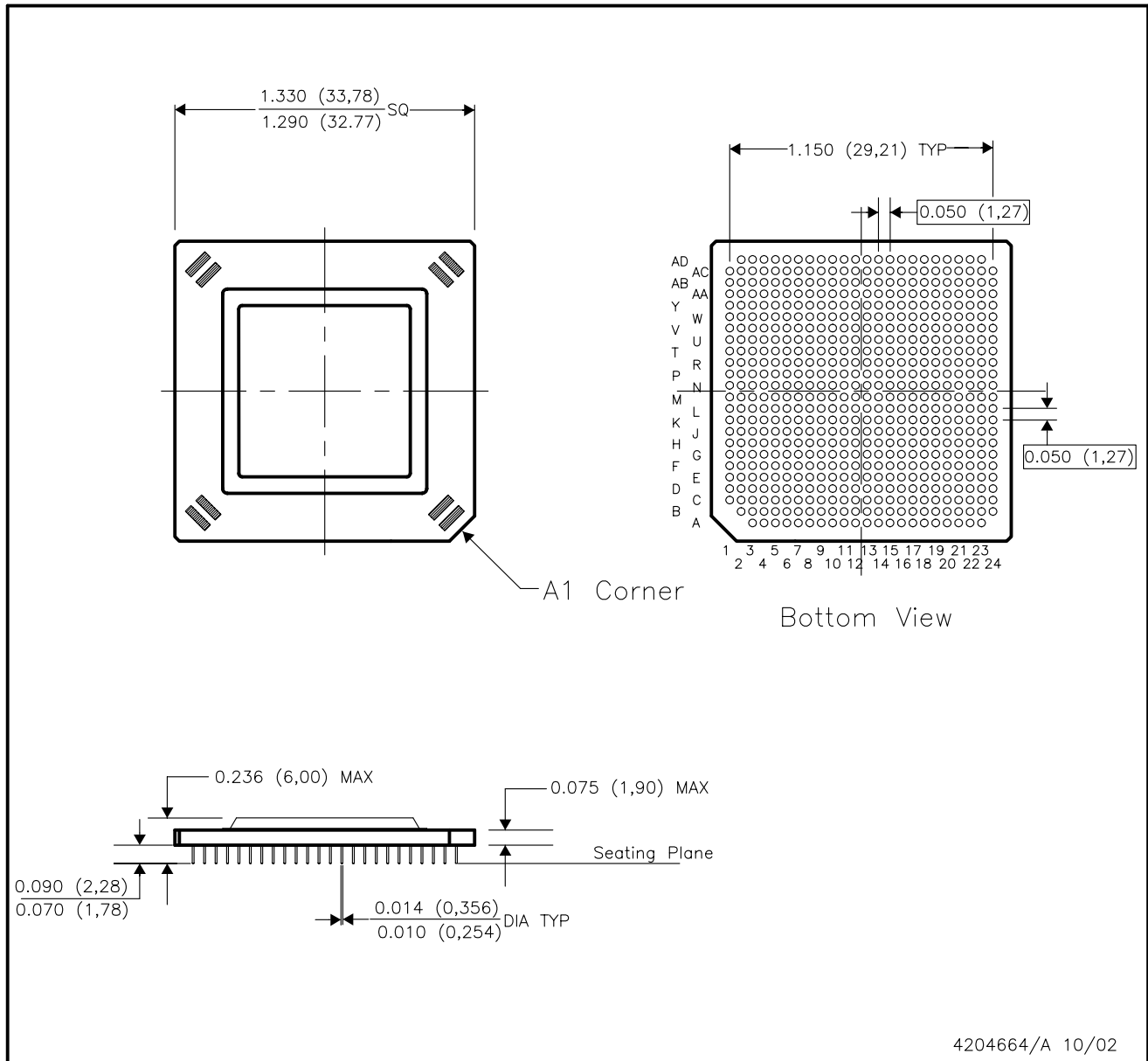


GAD (S-CPGA-P570)

CERAMIC PIN GRID ARRAY



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Flip chip application only
 - D. This package is hermetically sealed with a metal lid.

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